



# SGM8270SH-4

## Low Noise, Precision, High Voltage, Rail-to-Rail I/O Operational Amplifier

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### GENERAL DESCRIPTION

The SGM8270SH-4 is a quad, low noise, precision operational amplifier, optimized for high voltage operation from 3.3V to 33V single supply or  $\pm 1.65\text{V}$  to  $\pm 16.5\text{V}$  dual power supplies. It provides rail-to-rail input with a wide input common mode voltage range and rail-to-rail output voltage swing.

Furthermore, the SGM8270SH-4 provides high slew rate, low noise, low offset current and voltage, and low bias current.

The SGM8270SH-4 is available in a Green SOIC-14 package. It is specified over the extended  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  temperature range.

### FEATURES

- Rail-to-Rail Input and Output
- Wide Input Common Mode and Differential Voltage Ranges
- Low Input Offset Voltage:  $\pm 1.2\text{mV}$  (MAX)
- Low Input Bias Current
- Low Input Offset Current
- High Input Impedance
- Output Short-Circuit Protection
- Low Noise:  $20\text{nV}/\sqrt{\text{Hz}}$  at 1kHz
- Gain-Bandwidth Product: 2.7MHz
- High Slew Rate:  $8\text{V}/\mu\text{s}$
- $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  Operating Temperature Range
- Available in a Green SOIC-14 Package

### APPLICATIONS

High Impedance Sensor  
Photodiode Amplifier  
High End, Professional Audio  
DAC Output Amplifier  
Medical Equipment

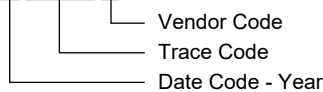
**PACKAGE/ORDERING INFORMATION**

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8270SH-4	SOIC-14	-40°C to +125°C	SGM8270SH-4XS14G/TR	08EXS14 XXXXX	Tape and Reel, 2500

**MARKING INFORMATION**

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.

**XXXXX**



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, +V <sub>S</sub> to -V <sub>S</sub> .....	36V
Differential Input Voltage,  V <sub>ID</sub>   .....	(+V <sub>S</sub> ) - (-V <sub>S</sub> )
Input/Output Voltage Range.....	(-V <sub>S</sub> ) - 0.3V to (+V <sub>S</sub> ) + 0.3V
Package Thermal Resistance	
SOIC-14, θ <sub>JA</sub> .....	81°C/W
SOIC-14, θ <sub>JB</sub> .....	44°C/W
SOIC-14, θ <sub>JC</sub> .....	32°C/W
Junction Temperature.....	+150°C
Storage Temperature Range.....	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+260°C
ESD Susceptibility <sup>(1)(2)</sup>	
HBM.....	±6000V
CDM .....	±1000V

NOTES:

1. For human body model (HBM), all pins comply with ANSI/ESDA/JEDEC JS-001 specifications.
2. For charged device model (CDM), all pins comply with ANSI/ESDA/JEDEC JS-002 specifications.
3. It is recommended that CMOS device adopts the proper power supply sequence. Always sort the V<sub>S</sub> first, followed by the inputs and outputs.

**RECOMMENDED OPERATING CONDITIONS**

Operating Temperature Range.....	-40°C to +125°C
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**OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

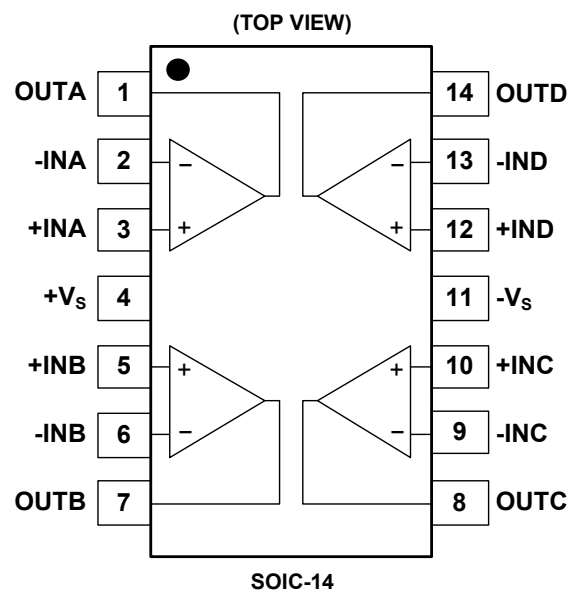
**ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

**DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

**PIN CONFIGURATION**



**ELECTRICAL CHARACTERISTICS**

( $V_S = \pm 1.65V$  to  $\pm 16.5V$  and  $R_L = 2k\Omega$  connected to 0V, Full =  $-40^\circ C$  to  $+125^\circ C$ , typical values are at  $T_A = +25^\circ C$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
<b>Input Characteristics</b>							
Input Offset Voltage	$V_{OS}$	$V_{CM} = 0V$	+25°C		±0.4	±1.2	mV
			Full			±1.4	
Input Offset Voltage Drift	$\Delta V_{OS}/\Delta T$		Full		1.2		µV/°C
Input Bias Current	$I_B$	$V_{CM} = 0V$	+25°C		±5	±200	pA
			+85°C			±1	nA
			Full			±20	nA
Input Offset Current	$I_{OS}$	$V_{CM} = 0V$	+25°C		±5	±200	pA
			+85°C			±1	nA
			Full			±20	nA
Maximum Input Difference Bias Current	$I_{ID}$	$V_S = \pm 16.5V, V_{ID} = \pm 16.5V$	+25°C		0.01	0.5	µA
			Full			0.6	
Input Common Mode Voltage Range	$V_{CM}$		Full	$(-V_S) - 0.1$		$(+V_S) + 0.1$	V
Common Mode Rejection Ratio	CMRR	$V_S = \pm 16.5V,$ $(-V_S) - 0.1V < V_{CM} < (+V_S) - 1.5V$	+25°C	95	113		dB
			Full	92			
		$V_S = \pm 16.5V,$ $(-V_S) - 0.1V < V_{CM} < (+V_S) + 0.1V$	+25°C	82	98		
			Full	79			
Open-Loop Voltage Gain	$A_{OL}$	$(-V_S) + 0.2V < V_{OUT} < (+V_S) - 0.2V,$ $R_L = 10k\Omega$	+25°C	100	127		dB
			Full	97			
		$(-V_S) + 0.5V < V_{OUT} < (+V_S) - 0.5V,$ $R_L = 2k\Omega$	+25°C	98	127		
			Full	95			
<b>Output Characteristics</b>							
Output Voltage Swing from Rail	$V_{OUT}$	$V_S = \pm 16.5V, R_L = 10k\Omega$	+25°C		50	85	mV
			Full			110	
		$V_S = \pm 16.5V, R_L = 2k\Omega$	+25°C		255	350	
			Full			470	
Output Short-Circuit Current	$I_{SC}$	$V_S = \pm 16.5V$	+25°C	±30	±45		mA
<b>Power Supply</b>							
Operating Voltage Range	$V_S$		Full	3.3		33	V
Quiescent Current	$I_Q$	$I_{OUT} = 0A$	+25°C		2.2	3	mA
			Full			3.6	
Power Supply Rejection Ratio	PSRR	$V_S = 3.3V$ to $33V$	+25°C	105	122		dB
			Full	102			

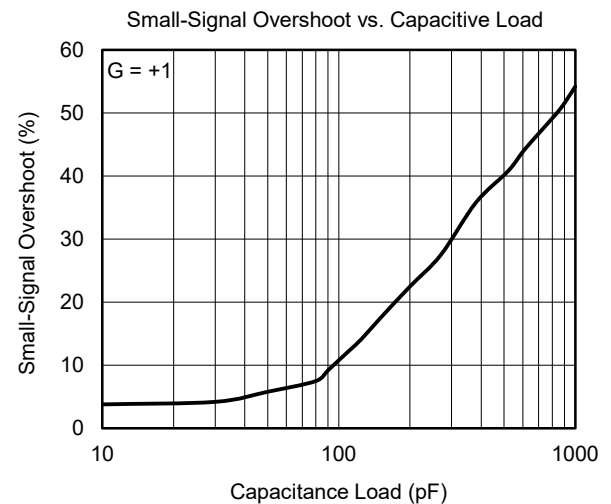
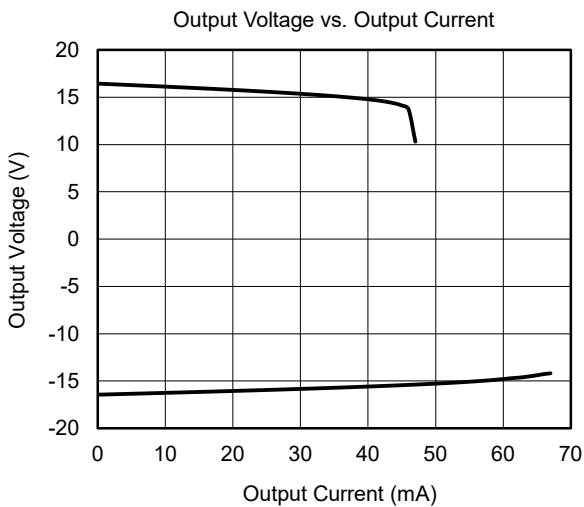
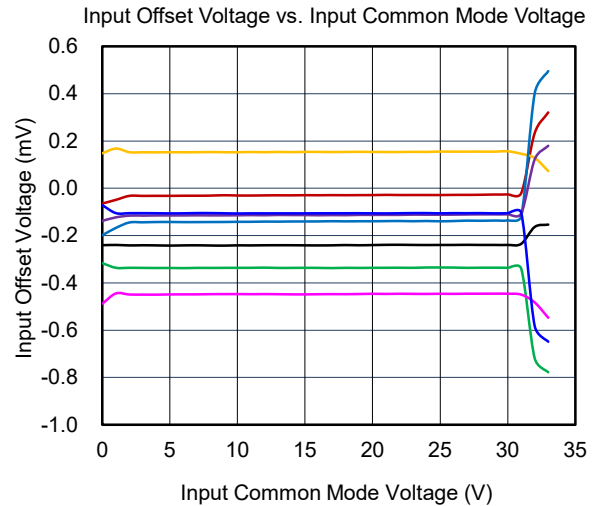
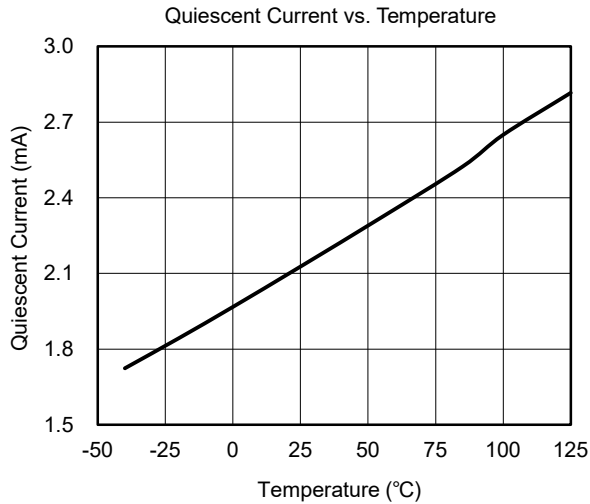
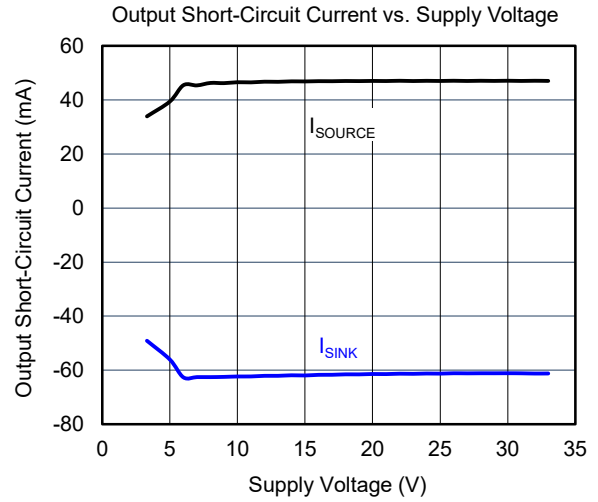
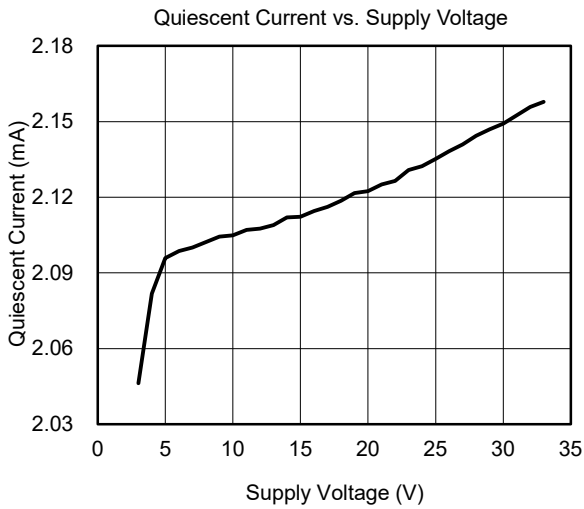
**ELECTRICAL CHARACTERISTICS (continued)**

( $V_S = \pm 1.65V$  to  $\pm 16.5V$  and  $R_L = 2k\Omega$  connected to 0V, Full =  $-40^\circ C$  to  $+125^\circ C$ , typical values are at  $T_A = +25^\circ C$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
<b>Dynamic Performance</b>							
Gain-Bandwidth Product	GBP	$C_L = 50pF$	$+25^\circ C$		2.7		MHz
Phase Margin	$\phi_o$	$C_L = 50pF$	$+25^\circ C$		60		$^\circ$
Slew Rate	SR	$V_S = \pm 2.5V$ to $\pm 16.5V$ , $G = +1$	$+25^\circ C$		8		V/ $\mu s$
Overload Recovery Time	ORT	$V_{IN} \times G > V_S$	$+25^\circ C$		1		$\mu s$
Total Harmonic Distortion + Noise	THD+N	$V_S = \pm 2.5V$ to $\pm 16.5V$ , $V_{OUT} = 2V_{P-P}$ , $f = 1kHz$ , $G = +1$ , $R_L = 600\Omega$	$+25^\circ C$		0.003		%
		$V_S = \pm 2.5V$ to $\pm 16.5V$ , $V_{OUT} = 2V_{P-P}$ , $f = 1kHz$ , $G = +1$ , $R_L = 2k\Omega$	$+25^\circ C$		0.001		
<b>Noise</b>							
Input Voltage Noise		$f = 0.1Hz$ to $10Hz$	$+25^\circ C$		3.5		$\mu V_{P-P}$
Input Voltage Noise Density	$e_n$	$f = 10Hz$	$+25^\circ C$		100		$nV/\sqrt{Hz}$
		$f = 1kHz$	$+25^\circ C$		20		
Input Current Noise Density	$i_n$	$f = 1kHz$	$+25^\circ C$		100		$fA/\sqrt{Hz}$

**TYPICAL PERFORMANCE CHARACTERISTICS**

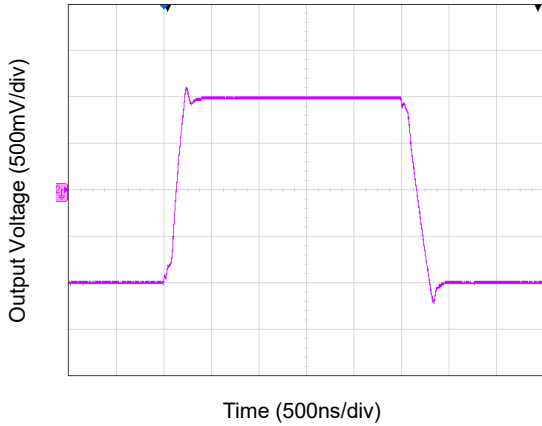
At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 16.5\text{V}$  and  $R_L = 2\text{k}\Omega$  connected to  $0\text{V}$ , unless otherwise noted.



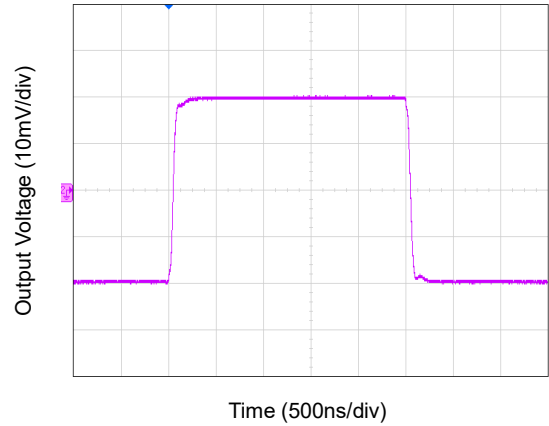
**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 16.5\text{V}$  and  $R_L = 2\text{k}\Omega$  connected to  $0\text{V}$ , unless otherwise noted.

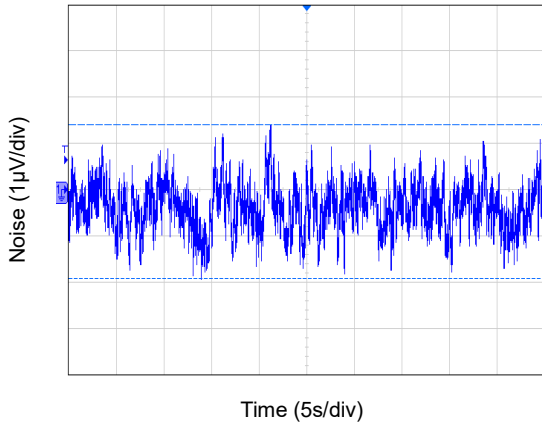
Large-Signal Step Response



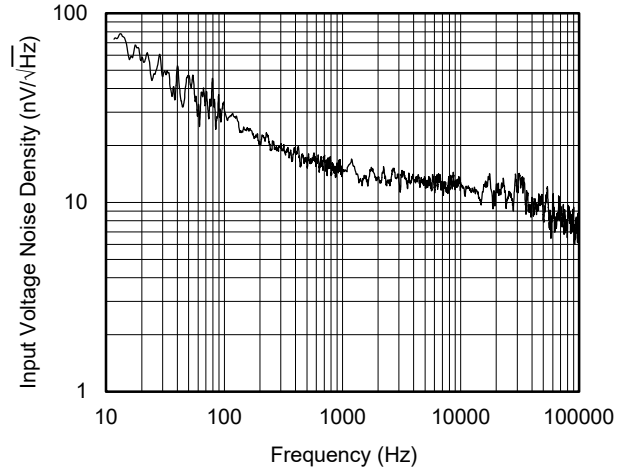
Small-Signal Step Response



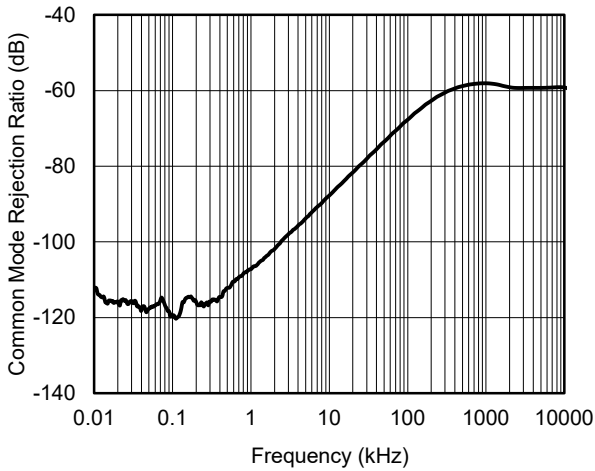
0.1Hz to 10Hz Input Voltage Noise



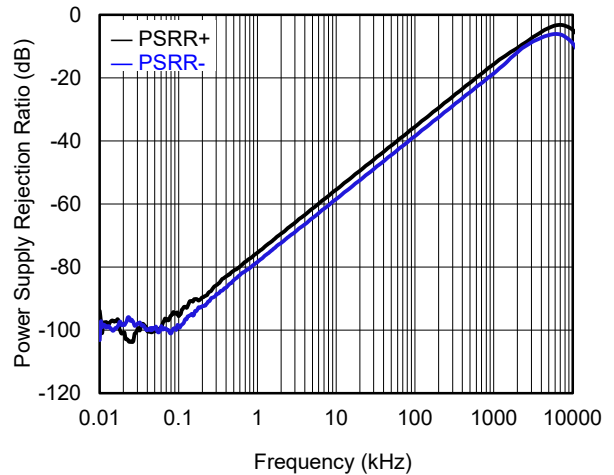
Input Voltage Noise Density vs. Frequency



CMRR vs. Frequency

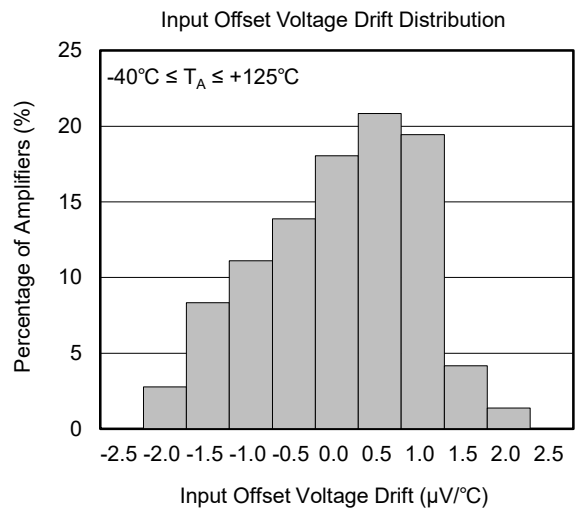
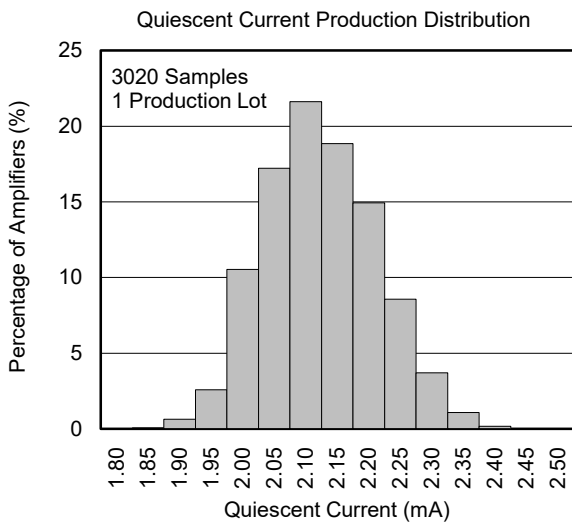
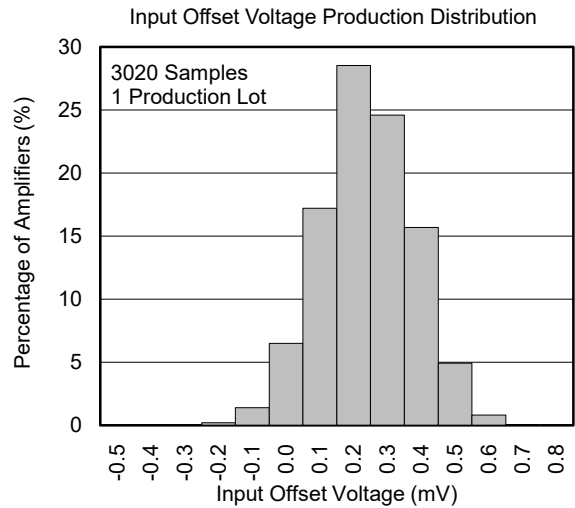
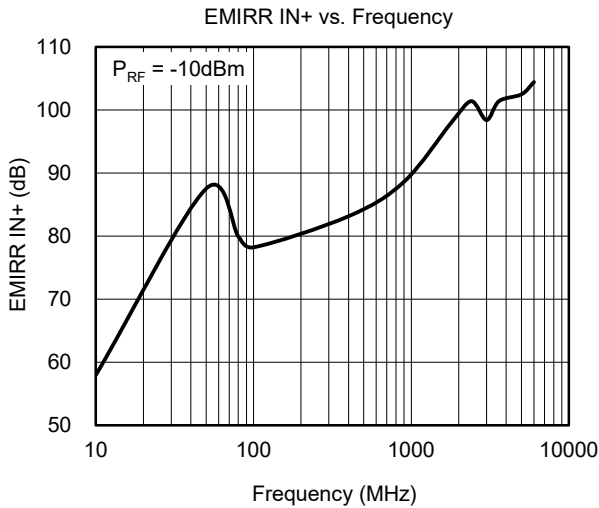
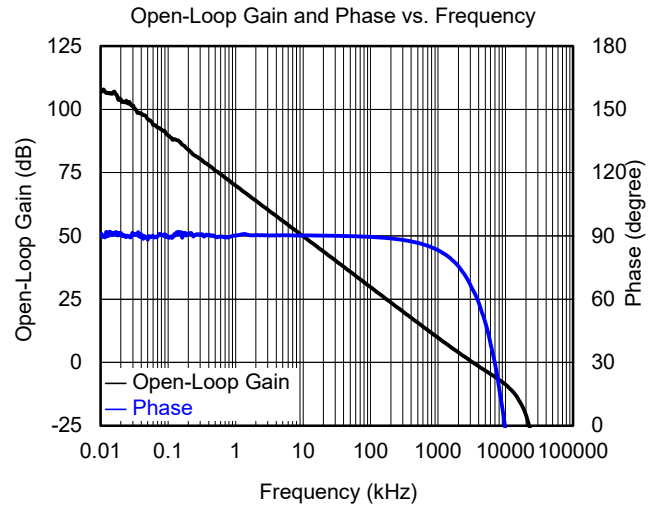
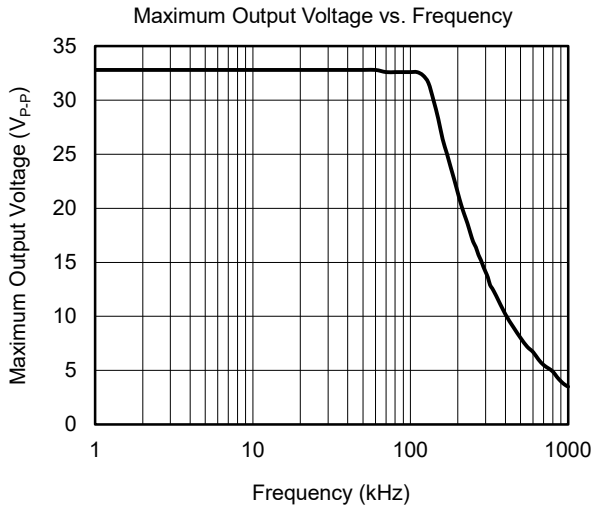


PSRR vs. Frequency



**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 16.5\text{V}$  and  $R_L = 2\text{k}\Omega$  connected to  $0\text{V}$ , unless otherwise noted.



**REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

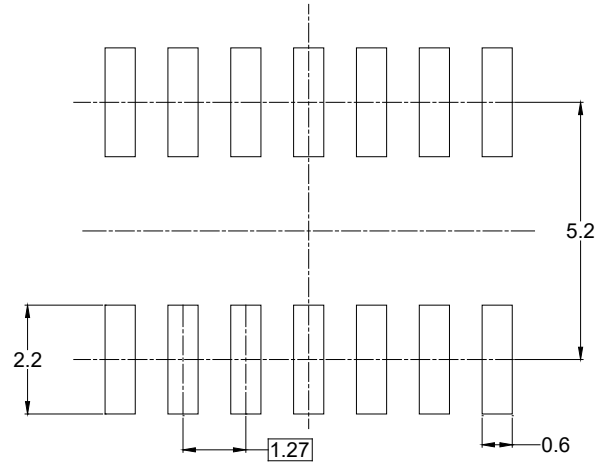
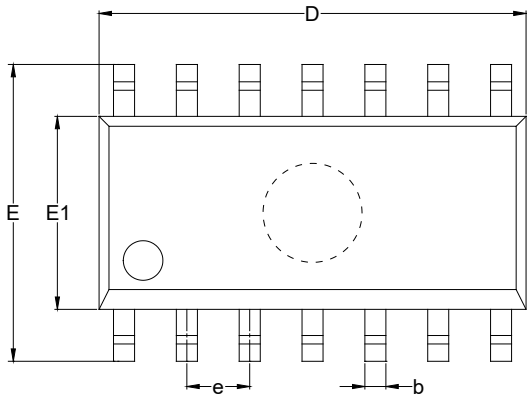
<b>Changes from Original (OCTOBER 2024) to REV.A</b>	<b>Page</b>
Changed from product preview to production data.....	All

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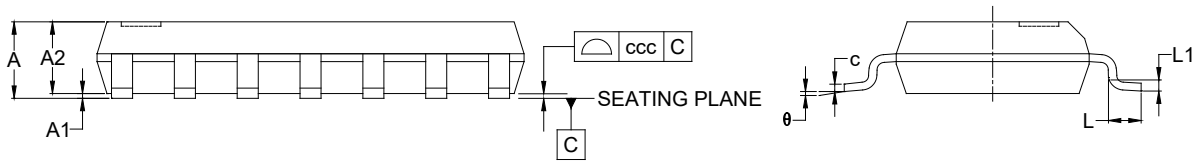


PACKAGE OUTLINE DIMENSIONS

SOIC-14



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.750
A1	0.100	-	0.250
A2	1.250	-	-
b	0.310	-	0.510
c	0.100	-	0.250
D	8.450	-	8.850
E	5.800	-	6.200
E1	3.800	-	4.000
e	1.270 BSC		
L	0.400	-	1.270
L1	0.250 TYP		
θ	0°	-	8°
ccc	0.100		

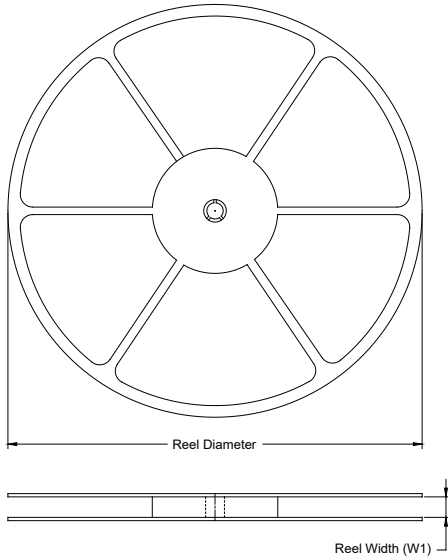
NOTES:

1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MS-012.

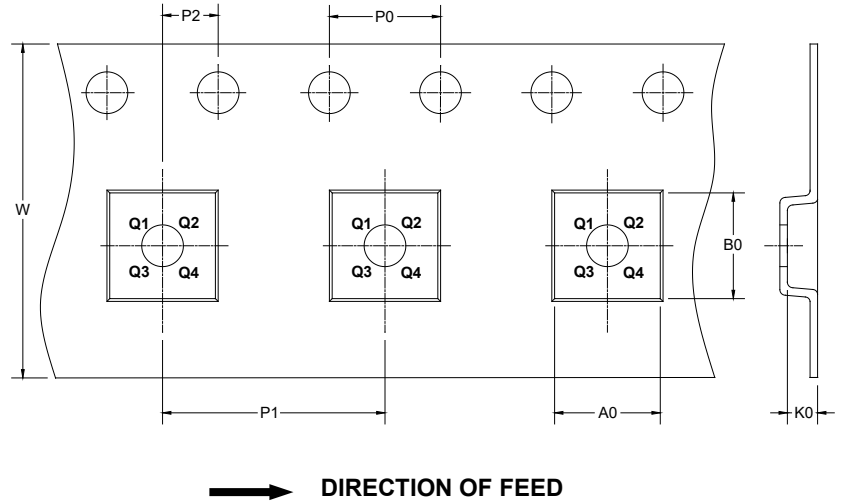
# PACKAGE INFORMATION

## TAPE AND REEL INFORMATION

### REEL DIMENSIONS



### TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

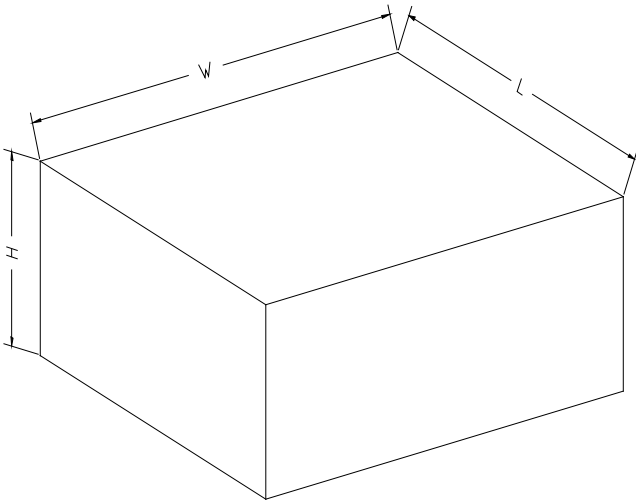
### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-14	13"	16.4	6.60	9.30	2.10	4.0	8.0	2.0	16.0	Q1

DD0001

# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002